

Power MOSFET, 190 A



PRODUCT SUMMARY				
V_{DSS}	100 V			
I _D DC	190 A			
R _{DS(on)}	$0.0065~\Omega$			
Туре	Modules - MOSFET			
Package	SOT-227			

FEATURES

- Fully isolated package
- Very low on-resistance
- · Fully avalanche rated
- Dynamic dV/dt rating
- · Low drain to case capacitance
- · Low internal inductance
- · Optimized for SMPS applications
- · Easy to use and parallel
- · Industry standard outline
- · Designed and qualified for industrial level
- UL approved file E78996



• Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION

High current density power MOSFETs are paralleled into a compact, high power module providing the best combination of switching, ruggedized design, very low on-resistance and cost effectiveness.

The isolated SOT-227 package is preferred for all commercial-industrial applications at power dissipation levels to approximately higher than 500 W. The low thermal resistance and easy connection to the SOT-227 package contribute to its universal acceptance throughout the industry.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Outline and deline work at W. 40 W.	I _D	T _C = 40 °C	190		
Continuous drain current at V _{GS} 10 V		T _C = 100 °C	130	Α	
Pulsed drain current	I _{DM}		720		
Power dissipation	P_{D}	T _C = 25 °C	568	W	
Linear derating factor			2.7	W/°C	
Gate to source voltage	V _{GS}		± 20	V	
Single pulse avalanche energy	E _{AS} (2)		700	mJ	
Avalanche current	I _{AR} (1)		180	Α	
Repetitive avalanche energy	E _{AR} (1)		48	mJ	
Peak diode recovery dV/dt	dV/dt (3)		5.7	V/ns	
Operating junction and storage temperature range	T _J , T _{Stg}		- 55 to + 150	°C	
Insulation withstand voltage (AC-RMS)	V _{ISO}		2.5	kV	
Mounting torque		M4 screw	1.3	Nm	

- (1) Repetitive rating; pulse width limited by maximum junction temperature.
- $\begin{array}{ll} \mbox{(2)} & \mbox{Starting T}_J = 25 \ ^{\circ}\mbox{C}, \ L = 43 \ \mu\mbox{H}, \ R_g = 25 \ \Omega, \ I_{AS} = 180 \ A. \\ \mbox{(3)} & \mbox{I}_{SD} \leq 180 \ A, \ d\mbox{I/dt} \leq 83 \ A\slash A\slash V_{DD} \leq V_{(BR)DSS}, \ T_J \leq 150 \ ^{\circ}\mbox{C}. \\ \end{array}$

Revision: 13-Aug-13 Document Number: 93459



THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Junction and storage temperature range	T _J , T _{Stg}		- 55	-	150	°C
Junction to case	R_{thJC}		-	-	0.22	°C/W
Case to heatsink	R _{thCS}	Flat, greased surface	-	0.05	-	C/VV
Weight			-	30	-	g
Mounting torque			-	-	1.3	Nm
Case style				SOT	-227	

ELECTRICAL CHARACTERISTICS (T _J = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain to source breakdown voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	100	-	-	V
Breakdown voltage temperature coefficient	$\Delta V_{(BR)DSS}/\Delta T_J$	Reference to 25 °C, I _D = 1 mA	-	0.093	-	V/°C
Static drain to source on-resistance	R _{DS(on)}	V _{GS} = 10 V, I _D = 180 A	-	0.0054	0.0065	Ω
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2.0	3.3	4.35	V
Forward transconductance	9 _{fs}	V _{DS} = 25 V, I _D = 180 A	93	-	-	S
Duain to accuracy leakage accuracy		V _{DS} = 100 V, V _{GS} = 0 V	-	-	50	μΑ
Drain to source leakage current	I _{DSS}	V _{DS} = 80 V, V _{GS} = 0 V, T _J = 125 °C	-	-	500	
Gate to source forward leakage	I _{GSS}	V _{GS} = 20 V	-	-	200	nA
		V _{GS} = - 20 V	-	-	- 200	
Total gate charge	Qg	V _{DS} = 80 V		250	-	
Gate to source charge	Q _{gs}			40	-	nC
Gate to drain ("Miller") charge	Q _{gd}			110	-	
Turn-on delay time	t _{d(on)}	V _{DD} = 50 V	-	45	-	
Rise time	t _r	I _D = 180 A	-	351	-	
Turn-off delay time	t _{d(off)}	R_g = 2.0 Ω (internal)	-	181	-	ns
Fall time	t _f	$R_D = 0.27 \Omega$	-	335	-	1
Internal source inductance	L _S	Between lead, and center of die contact	-	5.0	-	nH
Input capacitance	C _{iss}	V _{GS} = 0 V	-	10 700	-	
Output capacitance	C _{oss}	V _{DS} = 25 V	-	2800	-	pF
Reverse transfer capacitance	C _{rss}	f = 1.0 MHz	-	1300	-	

SOURCE-DRAIN RATINGS AND CHARACTERISTICS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Continuous source current (body diode)	Is	MOSFET symbol showing the integral	ı	-	190	Α
Pulsed source current (body diode)	I _{SM}	reverse p-n junction diode.	ı	-	740	
Diode forward voltage	V _{SD}	$T_J = 25 ^{\circ}\text{C}, I_S = 180 \text{A}, V_{GS} = 0 \text{V}$	-	1.0	1.3	V
Reverse recovery time	t _{rr}	$T_J = 25 ^{\circ}\text{C}, \ I_F = 180 \text{A}, \ dI/dt = 100 \text{A/}\mu\text{s}$	-	300	-	ns
Reverse recovery charge	Q _{rr}		-	2.6	-	μC
Forward turn-on time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S + L_D$)				



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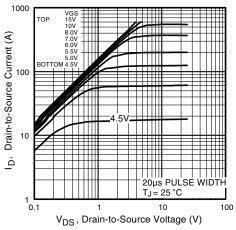
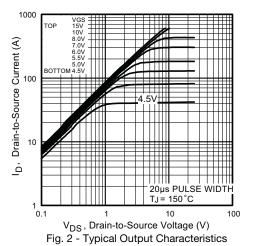


Fig. 1 - Typical Output Characteristics



1000 (V) tubuno 100 (V) (V)

Fig. 3 - Typical Transfer Characteristics

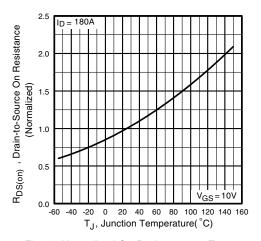


Fig. 4 - Normalized On-Resistance vs. Temperature

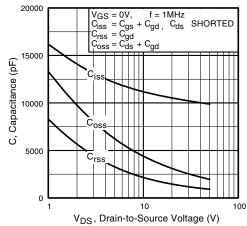


Fig. 5 - Typical Capacitance vs. Drain to Source Voltage

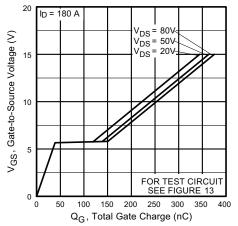


Fig. 6 - Typical Gate Charge vs. Gate to Source Voltage

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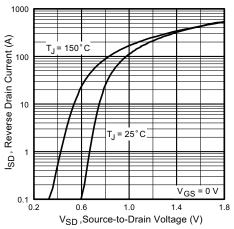


Fig. 7 - Typical Source Drain Diode Forward Voltage

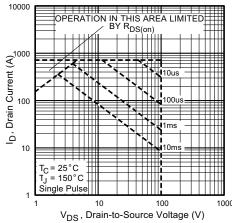


Fig. 8 - Maximum Safe Operating Area

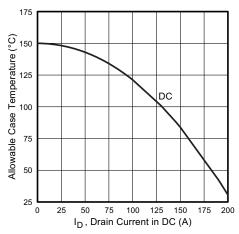


Fig. 9 - Maximum Drain Current vs. Case Temperature

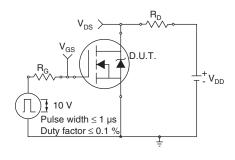


Fig. 10a - Switching Time Test Circuit

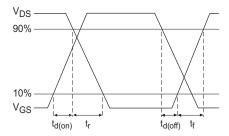


Fig. 10b - Switching Time Waveforms

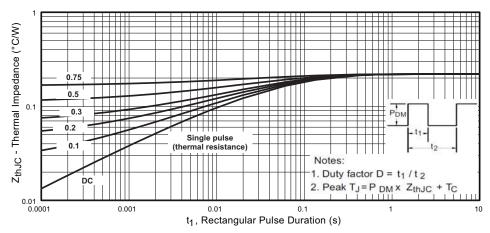


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction to Case

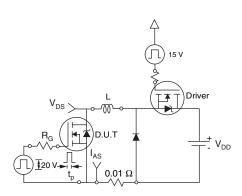


Fig. 12a - Unclamped Inductive Test Circuit

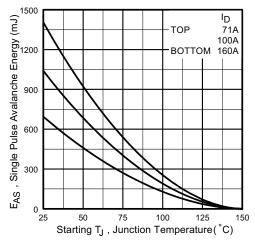


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

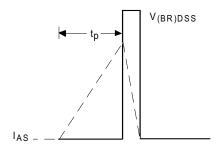


Fig. 12b - Unclamped Inductive Waveforms

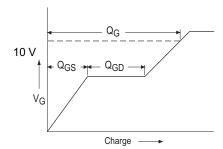


Fig. 13a - Basic Gate Charge Waveform

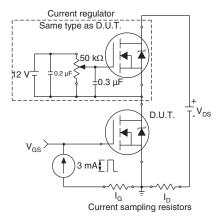


Fig. 13b - Gate Charge Test Circuit

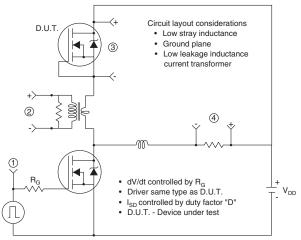
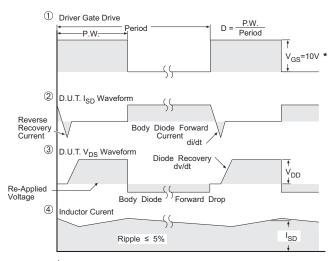


Fig. 13c - Peak Diode Recovery dV/dt Test Circuit



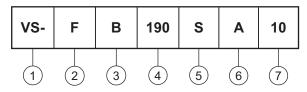
* V_{GS} = 5V for Logic Level Devices

Fig. 14 - For N-Channel Power MOSFETs



ORDERING INFORMATION TABLE

Device code



- 1 Vishay Semiconductors product
- 2 Power MOSFET
- Generation 5 MOSFET
- 4 Current rating (190 = 190 A)
- 5 Single switch
- 6 Package indicator (SOT-227)
- 7 Voltage rating (10 = 100 V)

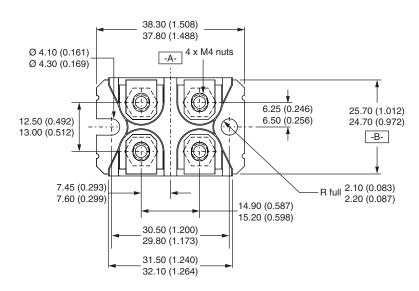
CIRCUIT CONFI	GURATION	
CIRCUIT	CIRCUIT CONFIGURATION CODE	CIRCUIT DRAWING
Single switch	S	G (2) Lead Assignment (S) (D) 4 1 (S) (G) (S) (S) (G) (S) (S) (S)

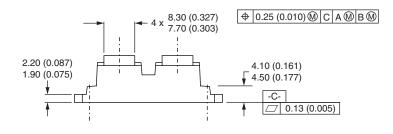
LINKS TO RELATED DOCUMENTS				
Dimensions <u>www.vishay.com/doc?95423</u>				
Packaging information	www.vishay.com/doc?95425			

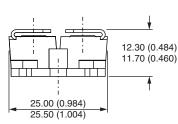


SOT-227 Generation II

DIMENSIONS in millimeters (inches)







Note

· Controlling dimension: millimeter



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